



N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
40	0.009 at V _{GS} = 10 V	17		
	0.012 at V _{GS} = 4.5 V	15		

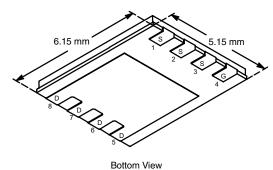
FEATURES

- TrenchFET[®] Power MOSFETS
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile



- PWM Optimized for Fast Switching
- 100 % R_a Tested

PowerPAK SO-8

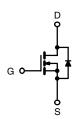


Ordering Information: Si7848DP-T1

Si7848DP-T1—E3 (Lead (Pb)-free)

APPLICATIONS

- DC/DC Converters
 - Synchronous Buck
 - Synchronous Rectifier



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V_{DS}	40		V	
Gate-Source Voltage		V_{GS}	± 20			
Continuous Drain Current (T _{.1} = 150 °C) ^a	T _A = 25 °C	I _D	17	10.4		
Continuous Drain Current (1) = 150 C)	T _A = 70 °C		13.7	8.3	Α	
Pulsed Drain Current		I _{DM}	50		A	
Avalanche Current	L = 0.1 mH	I _{AS}	30			
Continuous Source Current (Diode Conduction) ^a		I _S	4.5	1.67		
Mariana Barra Birata di ad	T _A = 25 °C	P _D	5	1.83	W	
Maximum Power Dissipation ^a	T _A = 70 °C		3.2	1.2	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	– 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}			260		1	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian III de di contra de la Arrela contra de la Contra	t ≤ 10 sec	R _{thJA}	20	25	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		55	68		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.8	2.2		

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

a. Surface Mounted on 1" x 1" FR4 Board.
b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

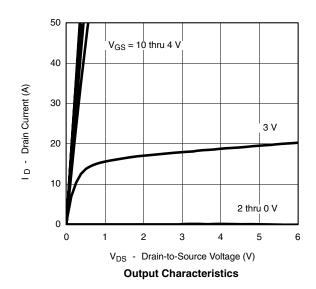
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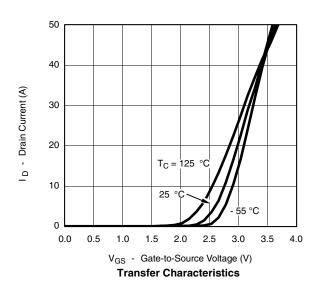


Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1		
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Drain-Source On-State Resistance ^a	_	V _{GS} = 10 V, I _D = 14 A		0.0075	0.009		
	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$		0.0095	0.012	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 14 A		50		S	
Diode Forward Voltage ^a	V _{SD}	$I_S = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic ^b	L.		- II	•	<u>. </u>		
Total Gate Charge	Q_g			18.5	28	nC	
Gate-Source Charge	Q _{gs} \	$V_{DS} = 20 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 14 \text{ A}$		6			
Gate-Drain Charge	Q _{gd}			7.5			
Gate Resistance	R_g		0.1	0.8	1.1	Ω	
Turn-On Delay Time	t _{d(on)}			15	30		
Rise Time	t _r	V_{DD} = 20 V, R_L = 20 Ω		10	20	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		50	100		
Fall Time	t _f			20	40		
Source-Drain Reverse Recovery Time t _{rr}		I _F = 2.8 A, di/dt = 100 A/µs		30	60		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted





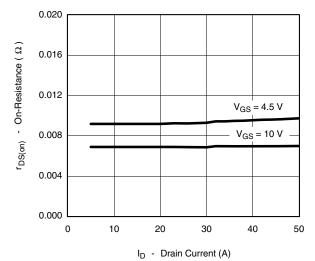
Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.



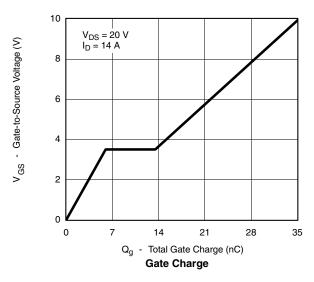


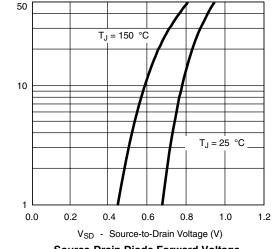


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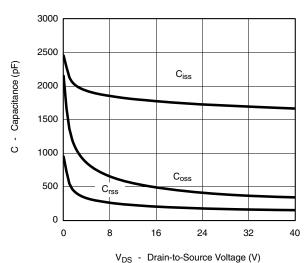


On-Resistance vs. Drain Current

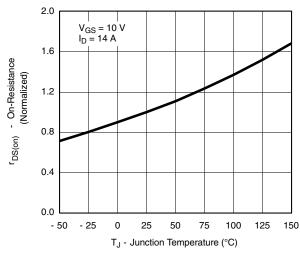




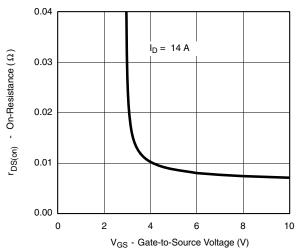
Source-Drain Diode Forward Voltage







On-Resistance vs. Junction Temperature



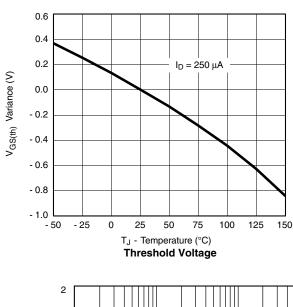
On-Resistance vs. Gate-to-Source Voltage

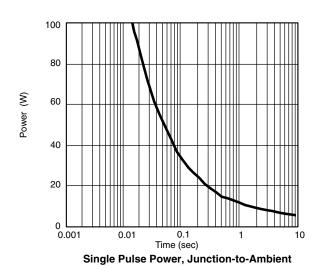
- Source Current (A)

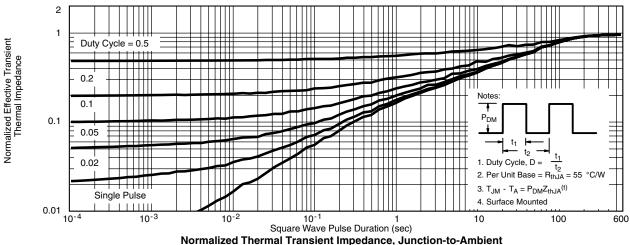
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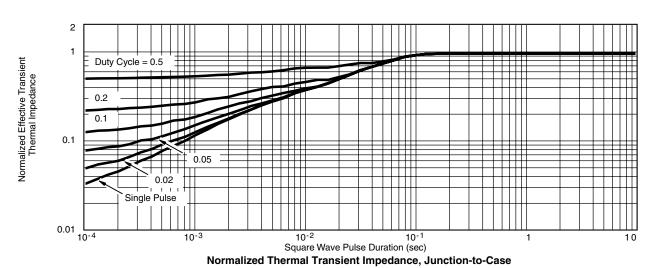
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TYPICAL CHARACTERISTICS 25 °C, unless noted









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